

SPICE Device Model SiA415DJ Vishay Siliconix

P-Channel 20-V (D-S) MOSFET

CHARACTERISTICS

- P-Channel Vertical DMOS
- Macro Model (Subcircuit Model)
- Level 3 MOS

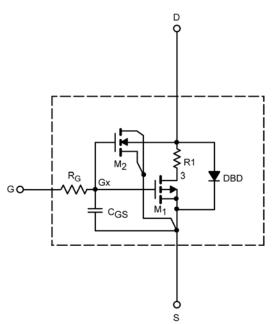
- Apply for both Linear and Switching Application
- Accurate over the -55 to 125°C Temperature Range
- Model the Gate Charge, Transient, and Diode Reverse Recovery Characteristics

DESCRIPTION

The attached spice model describes the typical electrical characteristics of the p-channel vertical DMOS. The subcircuit model is extracted and optimized over the -55 to 125° C temperature ranges under the pulsed 0-V to 5-V gate drive. The saturated output impedance is best fit at the gate bias near the threshold voltage.

SUBCIRCUIT MODEL SCHEMATIC

A novel gate-to-drain feedback capacitance network is used to model the gate charge characteristics while avoiding convergence difficulties of the switched C_{gd} model. All model parameter values are optimized to provide a best fit to the measured electrical data and are not intended as an exact physical interpretation of the device.



This document is intended as a SPICE modeling guideline and does not constitute a commercial product data sheet. Designers should refer to the appropriate data sheet of the same number for guaranteed specification limits.



| SPECIFICATIONS (T _J = 25°C UNLESS OTHERWISE NOTED) | | | | | |
|---|---------------------|---|-------------------|------------------|------|
| Parameter | Symbol | Test Condition | Simulated Data | Measured Data | Unit |
| Static | | | • | | |
| Gate Threshold Voltage | V _{GS(th)} | V_{DS} = V_{GS} , I_D = -250 μ A | 1 | | V |
| Drain-Source On-State Resistance ^a | r _{DS(on)} | V_{GS} = -4.5 V, I _D = -5.6 A | 0.028 | 0.029 | Ω |
| | | V_{GS} = -2.5 V, I _D = -2 A | 0.041 | 0.042 | |
| Forward Transconductance ^a | g _{fs} | V_{DS} = -10 V, I _D = -5.6 A | 17 | 20 | S |
| Diode Forward Voltage ^a | V _{SD} | I _S = -6.7 A | -0.81 | -0.80 | V |
| Dynamic ^b | | | • | | |
| Input Capacitance | C _{iss} | V _{DS} = -10 V, V _{GS} = 0 V, f = 1 MHz | 1219 | 1250 | pF |
| Output Capacitance | C _{oss} | | 228 | 250 | |
| Reverse Transfer Capacitance | C _{rss} | | 174 | 190 | |
| Total Gate Charge | Q _g | V_{DS} = -10 V, V_{GS} = -10 V, I_{D} = -8.4 A | 24.3 | 31 | nC |
| | | V_{DS} = -10 V, V_{GS} = -4.5 V, I_{D} = -8.4 A | 13 | 15 | |
| Gate-Source Charge | Q _{gs} | | 2.8 | 2.8 | |
| Gate-Drain Charge | Q _{gd} | | 5 | 5 | |

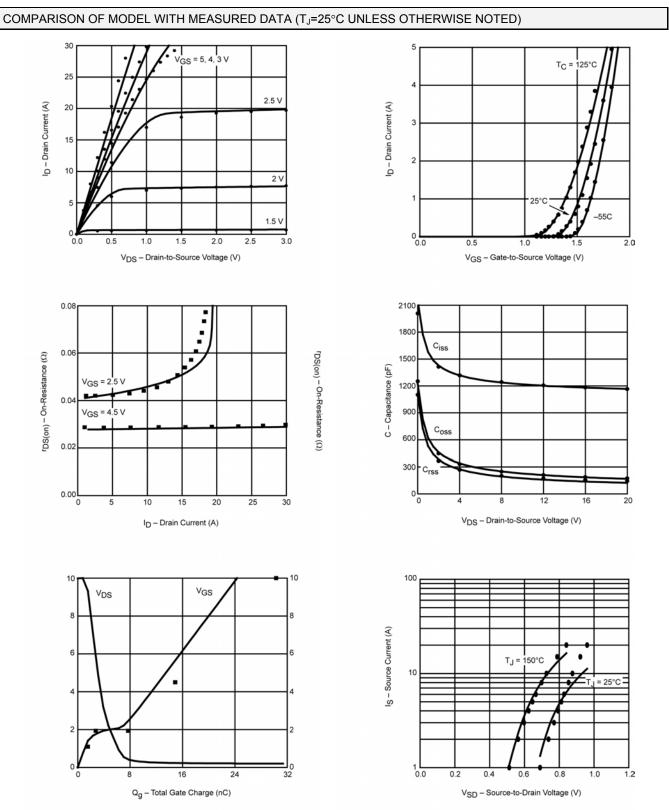
Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2%. b. Guaranteed by design, not subject to production testing.



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Note: Dots and squares represent measured data.



Vishay

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